

MOSFETs Silicon P-Channel MOS (U-MOSVI)

SSM3J353F

1. Applications

· Power Management Switches

2. Features

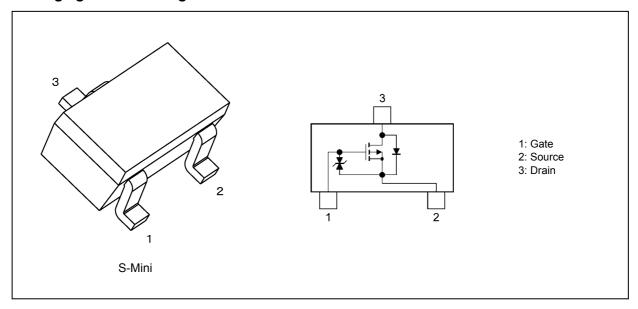
- (1) 4.0 V gate drive voltage.
- (2) Low drain-source on-resistance

 $: R_{DS(ON)} = 274 \text{ m}\Omega \text{ (max) } (@V_{GS} = -4.0 \text{ V}, I_D = -0.5 \text{ A})$

 $R_{DS(ON)}$ = 232 m Ω (max) (@V_{GS} = -4.5 V, I_D = -0.5 A)

 $R_{DS(ON)}$ = 150 m Ω (max) (@ V_{GS} = -10 V, I_D = -2.0 A)

3. Packaging and Pin Assignment





4. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

	Characteristics			Symbol	Rating	Unit
Drain-source voltage				V _{DSS}	-30	V
Gate-source voltage				V _{GSS}	-25 / +20	
Drain current (DC)			(Note 1)	I _D	-2.0	Α
Drain current (pulsed)	-		(Note 1), (Note 2)	I _{DP}	-4.0	
Power dissipation			(Note 3)	P_D	600	mW
Power dissipation		t ≤ 1s	(Note 3)		1200	
Channel temperature				T _{ch}	150	°C
Storage temperature				T _{stg}	-55 to 150	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Ensure that the channel temperature does not exceed 150 °C.
- Note 2: Repetitive rating; pulse width limited by maximum channel temperature.
- Note 3: Device mounted on a 25.4 mm × 25.4 mm × 1.6 mm FR4 glass epoxy board (Cu pad: 645 mm²)
- Note: This transistor is sensitive to electrostatic discharge and should be handled with care.
- Note: The MOSFETs in this device are sensitive to electrostatic discharge. When handling this device, the worktables, operators, soldering irons and other objects should be protected against anti-static discharge.
- Note: The channel-to-ambient thermal resistance, R_{th(ch-a)}, and the drain power dissipation, P_D, vary according to the board material, board area, board thickness and pad area. When using this device, be sure to take heat dissipation fully into account.



5. Electrical Characteristics

5.1. Static Characteristics (Unless otherwise specified, T_a = 25 °C)

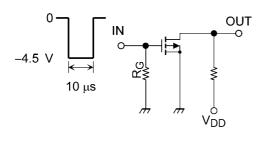
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	V _{GS} = ±16 V	_	_	±1	μА
Drain cut-off current		I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$	_	_	-1	
Drain-source breakdown voltage		V _{(BR)DSS}	I _D = -1 mA, V _{GS} = 0 V	-30	_	_	V
Drain-source breakdown voltage	(Note 1)	V _{(BR)DSX}	I _D = -1 mA, V _{GS} = 8 V	-22	_	_	
Gate threshold voltage		V _{th}	$V_{DS} = V_{GS}$, $I_{D} = -0.25$ mA	-1.0	_	-2.2	
Drain-source on-resistance	(Note 2)	R _{DS(ON)}	I _D = -0.5 A, V _{GS} = -4.0 V	_	198	274	mΩ
			I _D = -0.5 A, V _{GS} = -4.5 V	_	176	232	
			I _D = -2.0 A, V _{GS} = -10 V	_	125	150	
Forward transfer admittance	(Note 2)	Y _{fs}	V _{DS} = -10 V, I _D = -1.0 A	_	2.6	_	S

Note 1: If a reverse bias is applied between gate and source, this device enters $V_{(BR)DSX}$ mode. Note that the drain-source breakdown voltage is lowered in this mode.

5.2. Dynamic Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Input capacitance	C _{iss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V},$	_	159	_	pF
Reverse transfer capacitance	C _{rss}	f = 1 MHz	_	23		
Output capacitance	Coss		_	30	_	
Switching time (turn-on time)	t _{on}	$V_{DS} = -15 \text{ V}, I_{D} = -1.0 \text{ A},$	_	30	_	ns
Switching time (turn-off time)	t _{off}	V_{GS} = 0 to -4.5 V, R_{G} = 15 Ω	_	34		

5.3. Switching Time Test Circuit



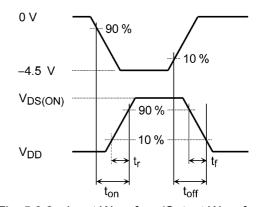


Fig. 5.3.1 Switching Time Test Circuit

Fig. 5.3.2 Input Waveform/Output Waveform

5.4. Gate Charge Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Total gate charge (gate-source plus gate-drain)	Q_g	V_{DD} = -15 V, I_{D} = -2.0 A,	_	3.4		nC
Gate-source charge 1	Q _{gs1}	V _{GS} = -4.5 V	_	1.5	_	
Gate-drain charge	Q _{gd}		_	1.4	_	

5.5. Source-Drain Characteristics (Unless otherwise specified, T_a = 25 °C)

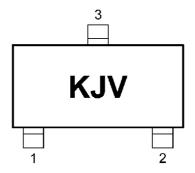
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Diode forward voltage	(Note 1)	V_{DSF}	$I_D = 2.0 \text{ A}, V_{GS} = 0 \text{ V}$	_	0.9	1.2	V

Note 1: Pulse measurement.

Note 2: Pulse measurement.



6. Marking



7. Characteristics Curves (Note)

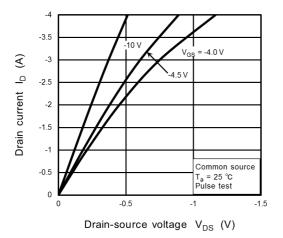


Fig. 7.1 I_D - V_{DS}

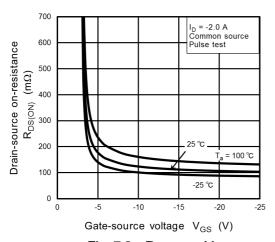


Fig. 7.3 R_{DS(ON)} - V_{GS}

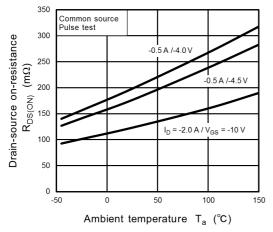


Fig. 7.5 $R_{DS(ON)}$ - T_a

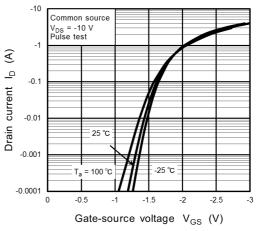


Fig. 7.2 I_D - V_{GS}

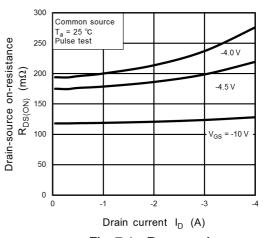


Fig. 7.4 R_{DS(ON)} - I_D

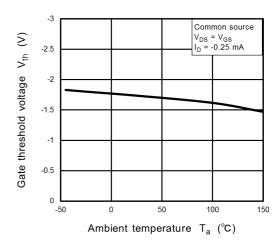


Fig. 7.6 V_{th} - T_a

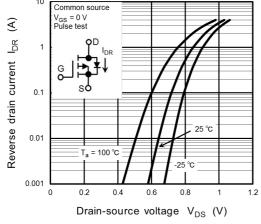


Fig. 7.7 IDR - VDS

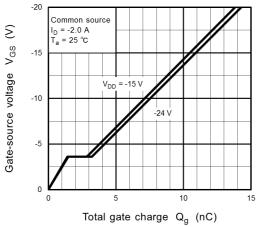


Fig. 7.9 Dynamic Input Characteristics

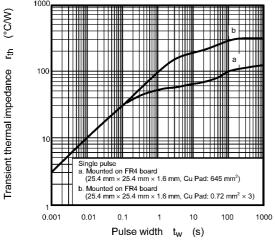


Fig. 7.11 rth - tw

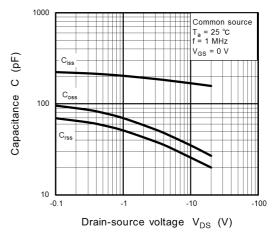


Fig. 7.8 C - V_{DS}

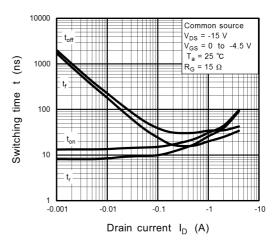


Fig. 7.10 t-I_D

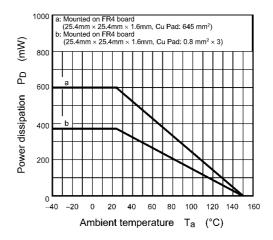


Fig. 7.12 P_D - T_a

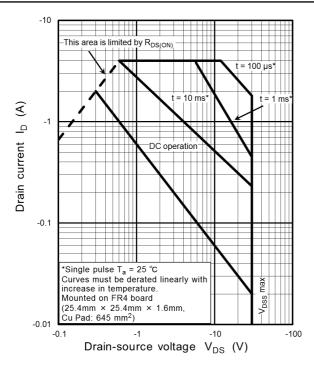


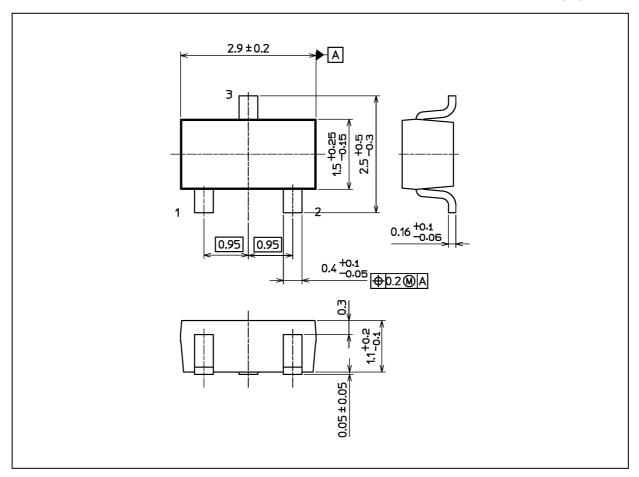
Fig. 7.13 Safe Operationg Area

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 12 mg (typ.)

F	Package Name(s)
TOSHIBA: 2-3F1S	
Nickname: S-Mini	



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